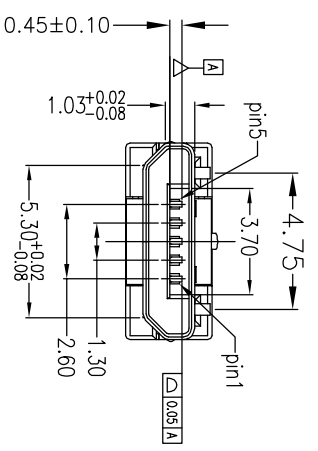
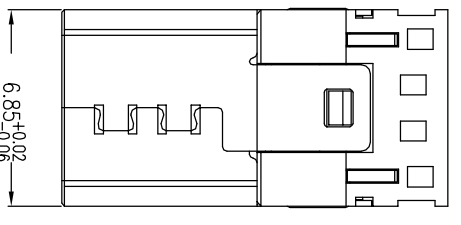
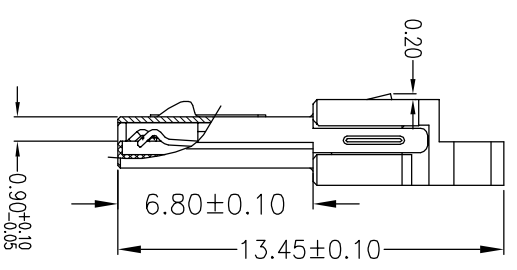
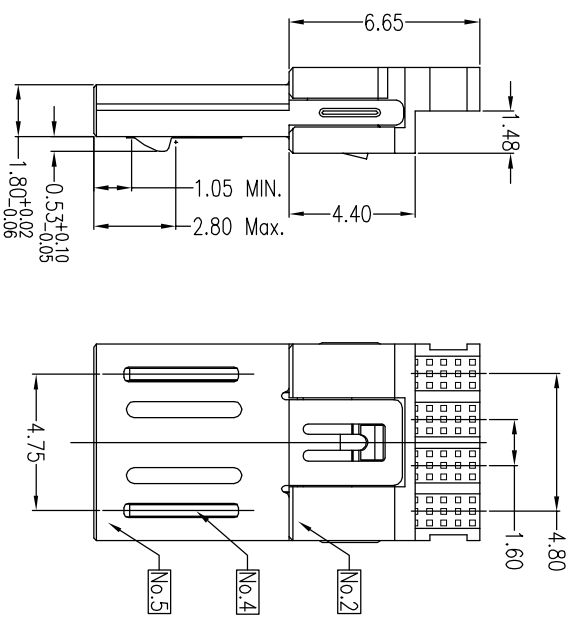
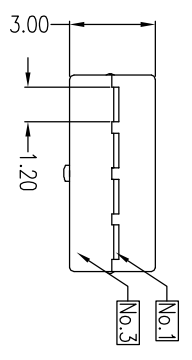


REV	DESCRIPTION	DATE	ECN NO.	CHANGER
A-0	New Drawing Release	13.11.06		朱兵雷
A-1	Update Drawing	14.12.19		Owen
A-2	Update Drawing	15.04.29		zw-lin



Specification

- 1.Voltage Rating:30V AC
- 2.Current Rating:1.5AMP.
- 3.Insulation Resistance:1000MΩ Min.
- 4.Contact Resistance:30mΩ Max.
- 5.Dielectric Withstanding Voltage:100V AC
- 6.Temperature Range:-20°C to +85°C
- 7.Insertion Force:35N Max.
- 8.Extraction Force:8N Min.

P/N NOTE:

AMIR-B1S32M-XX5X-X

- W=Without halogen
- O=UL94-V0
- Shell plate spec:
- T=Tin plated, N=Nickel plated
- Housing colour:
- B=Black, N=Nature, W=White
- Contact plate spec:
- 0=FU, 1=3U, 2=6U, 3=15U, 4=30U

1	Shell	SUS304	1	T=0.20 Ni PLATED 30u" Min.
2	Loacth	SUS301	2	T=0.40 No Plated
3	Insert Molding	LCP	1	UL94V-0 Black/Black/Gray
4	Housing	LCP	1	UL94V-0 Black/Black/Gray
5	Terminal	C5210	5	T=0.20mm>Contact area Au, Solder area Sn 120u", Underplated Ni 50u" Min.
NO.	VARIETY	MATERIAL	QTY	REMARK

CZT DONGGUAN ZHENGDE (YIHUA) CONNECTOR CO., LTD

X: ±0.38	X: ±4'	UNIT:	mm	DR:	Owen	TITLE:	MICRO USB 2.0 5P BM Solder Type
.X ±0.25	X' ±2'	3RD:	⊕	DE:	Owen	SHEET:	1/1
.XX±0.20	.XX'	SCALE:	1:1	CHKD:		P/N:	AMIR-B1S32M-XX5-X
.XXX±0.10	.XXX'	REV:	A-2	APPD:		D/N:	5340-0032 M/N:
CUSTOMER DRAWING							